

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NOZOMU HARADA	04/28/2022
KOJI SAKUI	04/28/2022
RECEIVING PARTY DATA	
Name:	UNISANTIS ELECTRONICS SINGAPORE PTE.
Street Address:	111, NORTH BRIDGE ROAD, #23-05
Internal Address:	PENINSULA PLAZA
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	179098
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17735414
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	TADASHI HORIE/KAORI WILLIAMS
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Address Line 4:	CHICAGO, ILLINOIS 60610
ATTORNEY DOCKET NUMBER:	13773/350
NAME OF SUBMITTER:	TADASHI HORIE
SIGNATURE:	/Tadashi Horie/
DATE SIGNED:	05/03/2022
Total Attachments: 2	
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ASSIGNMENT

WHEREAS, Nozomu HARADA and Koji SAKUI, hereinafter called the "Assignors", have made the invention described in the United States patent application entitled SEMICONDUCTOR MEMORY DEVICE, executed by Assignors on the same date as, or on a date prior to, this Assignment;

WHEREAS, Unisantis Electronics Singapore Pte. Ltd., a corporation organized and existing under the laws of Singapore, having a place of business at 111, North Bridge Road, #23-05, Peninsula Plaza, Singapore 179098, hereinafter called the "Assignee", desires to acquire the entire right, title and interest in and to the invention and the patent application identified above, and all patents which may be obtained for said invention, as set forth below;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other valuable and legally sufficient consideration, the receipt of which by the Assignors from the Assignee is hereby acknowledged, the Assignors have sold, assigned and transferred, and by these presents do sell, assign and transfer to the Assignee, the entire right, title and interest for the United States in and to the invention and the patent application identified above, and any patents that may issue for said invention in the United States; together with the entire right, title and interest in and to said invention and all patent applications and patents therefor in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; together with the entire right, title and interest in and to all continuations, divisions, renewals and extensions of any of the patent applications and patents defined above; to have and to hold for the sole and exclusive use and benefit of the Assignee, its successors and assigns, to the full end of the term or terms for all such patents.

The Assignors hereby covenant and agree, for both the Assignors and the Assignors' legal representatives, that the Assignors will assist the Assignee in the prosecution of the patent application identified above; in the making and prosecution of any other patent applications that the Assignee may elect to make covering the invention identified above; in vesting in the Assignee like exclusive title in and to all such other patent applications and patents; and in the prosecution of any interference which may arise involving said invention, or any such patent application or patent; and that the Assignors will execute and deliver to the

Assignee any and all additional papers which may be requested by the Assignee to carry out the terms of this Assignment.

The Commissioner of Patents and Trademarks is hereby authorized and requested to issue patents to the Assignee in accordance with the terms of this Assignment.

IN TESTIMONY WHEREOF, the Assignors have executed this agreement.

DATE:	<u>April 28, 2022</u>	<u>Nozomu Harada</u> Nozomu HARADA
WITNESSED:		
DATE:	_____	_____
DATE:	_____	_____
DATE:	<u>April 28, 2022</u>	<u>Koji Sakui</u> Koji SAKUI
WITNESSED:		
DATE:	_____	_____
DATE:	_____	_____
DATE:	_____	_____
WITNESSED:		
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DATE:	_____	_____